

STD80N10F7, STF80N10F7, STH80N10F7-2, STP80N10F7

N-channel 100 V, 0.008 Ω typ., 80 A STripFET™ VII DeepGATE™ Power MOSFETs in DPAK, TO-220FP, H²PAK-2 and TO-220

Datasheet - production data

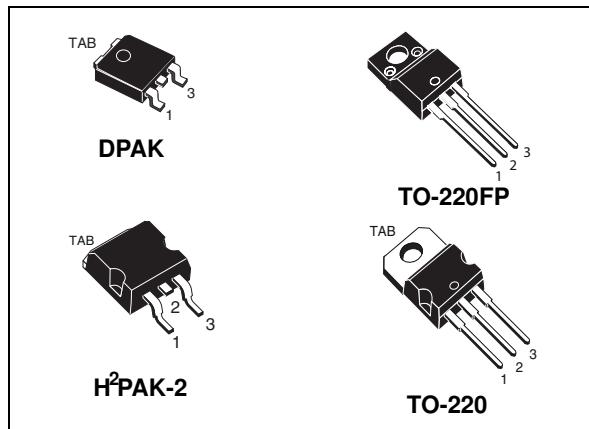
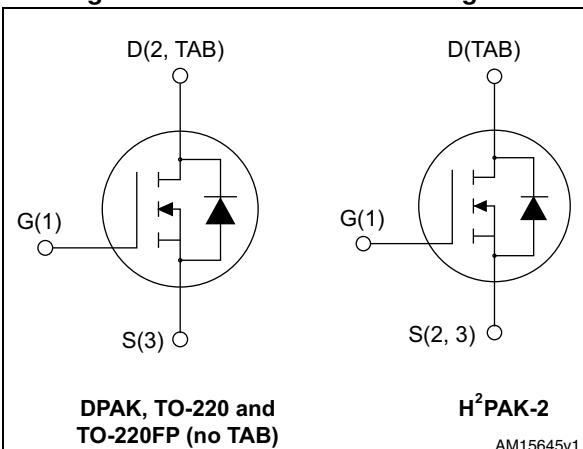


Figure 1. Internal schematic diagram



Features

| Order codes | $V_{DS} @ T_{Jmax}$ | $R_{DS(on)} \text{ max}$ | I_D | P_{TOT} |
|--------------|---------------------|--------------------------|-------|-----------|
| STD80N10F7 | 100 V | 0.01 Ω | 70 A | 85 W |
| STF80N10F7 | | 0.01 Ω | 40 A | 30 W |
| STH80N10F7-2 | | 0.0095 Ω | 80 A | 110 W |
| STP80N10F7 | | 0.01 Ω | | |

- Extremely low gate charge
- Ultra low on-resistance
- Low gate input resistance

Applications

- Switching applications

Description

These devices utilize the 7th generation of design rules of ST's proprietary STripFET™ technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest $R_{DS(on)}$ in all packages.

Table 1. Device summary

| Order codes | Marking | Package | Packaging |
|--------------|---------|----------------------|---------------|
| STD80N10F7 | 80N10F7 | DPAK | Tape and reel |
| STF80N10F7 | | TO-220FP | Tube |
| STH80N10F7-2 | | H ² PAK-2 | Tape and reel |
| STP80N10F7 | | TO-220 | Tube |

1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | | | Unit |
|--------------------------------|---|-------------|--------------------------------|----------|------|
| | | DPAK | H ² PAK-2 TO-220 | TO-220FP | |
| V _{DS} | Drain-source voltage | 100 | | | V |
| V _{GS} | Gate-source voltage | ± 20 | | | V |
| I _D | Drain current (continuous) at T _C = 25 °C | 70 | 80 | 40 | A |
| I _D | Drain current (continuous) at T _C = 100 °C | 48 | 54 | 30 | A |
| I _{DM} ⁽¹⁾ | Drain current (pulsed) | 280 | 320 | 160 | A |
| P _{TOT} | Total dissipation at T _C = 25 °C | 85 | 110 | 30 | W |
| T _{stg} | Storage temperature | - 55 to 175 | | | °C |
| T _j | Max. operating junction temperature | | | | |

1. Pulse width limited by safe operating area.

Table 3. Thermal data

| Symbol | Parameter | Value | | | | Unit |
|-----------------------|---|-------|----------|----------------------|--------|------|
| | | DPAK | TO-220FP | H ² PAK-2 | TO-220 | |
| R _{thj-pcb} | Thermal resistance junction-pcb max | 50 | | 35 | | °C/W |
| R _{thj-amb} | Thermal resistance junction-ambient max | | 62.5 | | 62.5 | °C/W |
| R _{thj-case} | Thermal resistance junction-case max | 1.76 | 5 | | 1.36 | °C/W |

2 Electrical characteristics

($T_C = 25^\circ\text{C}$ unless otherwise specified)

Table 4. On /off states

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------------|--|---|------|--------|----------|--------------------------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain-source breakdown voltage | $I_D = 250 \mu\text{A}, V_{GS} = 0$ | 100 | | | V |
| I_{DSS} | Zero gate voltage drain current ($V_{GS} = 0$) | $V_{DS} = 100 \text{ V}$ $V_{DS} = 100 \text{ V}, T_C = 125^\circ\text{C}$ | | | 1 100 | μA μA |
| I_{GSS} | Gate-body leakage current ($V_{DS} = 0$) | $V_{GS} = 20 \text{ V}$ | | | 100 | μA |
| $V_{GS(\text{th})}$ | Gate threshold voltage | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ | 2.5 | 3.5 | 4.5 | V |
| $R_{DS(\text{on})}$ | Static drain-source on-resistance | for DPAK, TO-220 and TO-220FP: $I_D = 40 \text{ A}, V_{GS}=10 \text{ V}$ | | 0.0085 | 0.010 | Ω |
| | | for H ² PAK-2: $V_{GS}=10 \text{ V}, I_D=40 \text{ A}$ | | 0.008 | 0.0095 | Ω |

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|--|------|------|------|------|
| C_{iss} | Input capacitance | $V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0$ | - | 3100 | - | pF |
| C_{oss} | Output capacitance | | - | 700 | - | pF |
| C_{rss} | Reverse transfer capacitance | | - | 45 | - | pF |
| Q_g | Total gate charge | $V_{DD} = 50 \text{ V}, I_D = 80 \text{ A}, V_{GS} = 10 \text{ V}$ | - | 45 | - | nC |
| Q_{gs} | Gate-source charge | | - | 18 | - | nC |
| Q_{gd} | Gate-drain charge | | - | 13 | - | nC |

Table 6. Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-------------------|---------------------|--|------|------|------|------|
| $t_d(\text{on})$ | Turn-on delay time | $V_{DD} = 50 \text{ V}, I_D = 40 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ | - | 19 | - | ns |
| t_r | Rise time | | - | 32 | - | ns |
| $t_d(\text{off})$ | Turn-off delay time | | - | 36 | - | ns |
| t_f | Fall time | | - | 13 | - | ns |

Table 7. Source drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------|---|------|------|------|------|
| I_{SD} | Source-drain current | | - | | 80 | A |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) | | - | | 320 | A |
| $V_{SD}^{(2)}$ | Forward on voltage | $I_{SD} = 80 \text{ A}, V_{GS} = 0$ | - | | 1.1 | V |
| t_{rr} | Reverse recovery time | $I_{SD} = 80 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$ $V_{DD} = 80 \text{ V}, T_j=150 \text{ }^\circ\text{C}$ | - | 70 | | ns |
| Q_{rr} | Reverse recovery charge | | - | 125 | | nC |
| I_{RRM} | Reverse recovery current | | - | 3.6 | | A |

1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration = 300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for DPAK, H²PAK-2 and TO-220

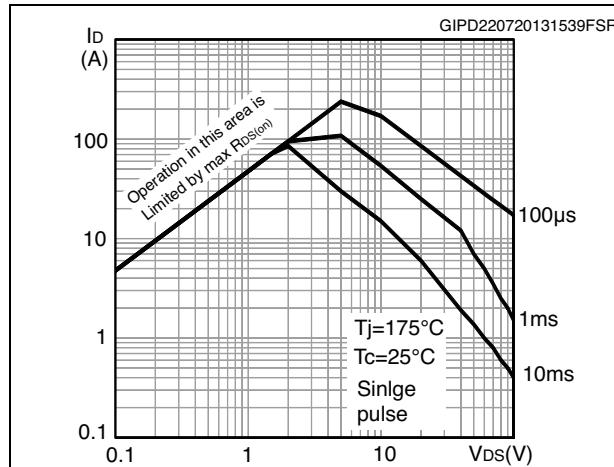


Figure 3. Thermal impedance for DPAK, H²PAK-2 and TO-220

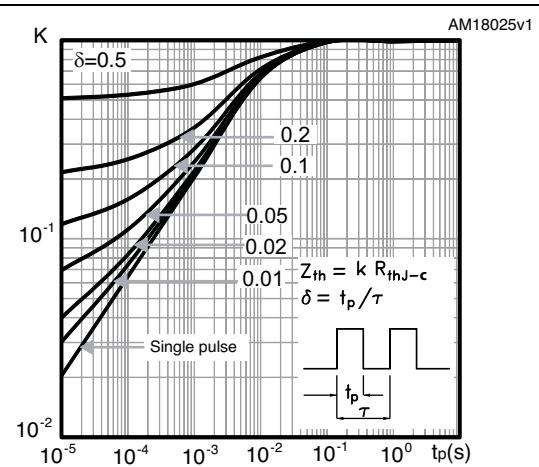


Figure 4. Safe operating area for TO-220FP

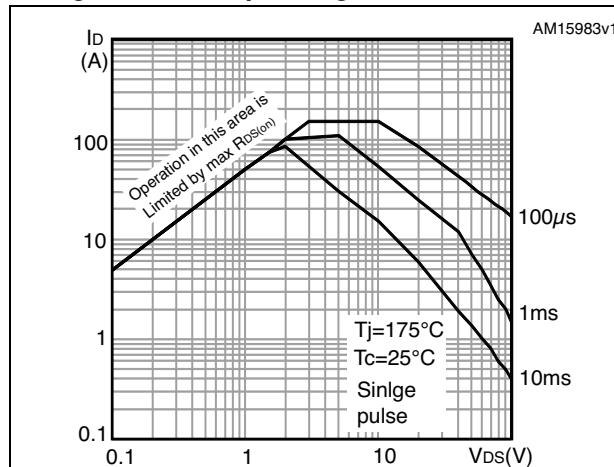


Figure 5. Thermal impedance for TO-220FP

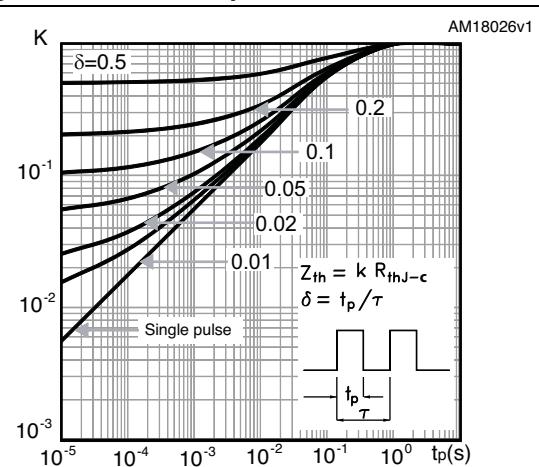


Figure 6. Output characteristics

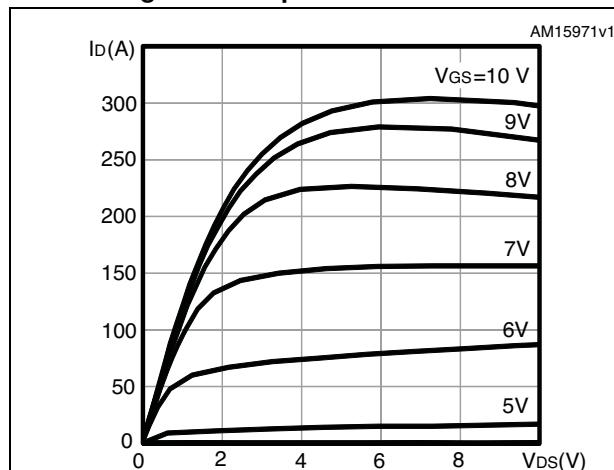


Figure 7. Transfer characteristics

